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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

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Details

Product Status	Obsolete
Core Processor	R32C/100
Core Size	16/32-Bit
Speed	50MHz
Connectivity	EBI/EMI, I ² C, IEBus, UART/USART
Peripherals	DMA, LVD, PWM, WDT
Number of I/O	156
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	96K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 34x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-LFQFP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f6416madfe-ua

Table 1.4 Performance Overview for the 144-pin Package (2/2)

Unit	Function	Explanation
Timer	Timer A	16-bit timer × 5 Timer mode, event counter mode, one-shot timer mode, pulse-width modulation (PWM) mode Two-phase pulse signal processing in event counter mode (two-phase encoder input) × 3
	Timer B	16-bit timer × 6 Timer mode, event counter mode, pulse frequency measurement mode, pulse-width measurement mode
	Three-phase motor control timer	Three-phase motor control timer × 1 (timers A1, A2, A4, and B2 used) 8-bit programmable dead time timer
Serial Interface	UART0 to UART10	Asynchronous/synchronous serial interface × 11 channels • I ² C-bus (UART0 to UART6) • Special mode 2 (UART0 to UART6) • IEBus (optional ⁽¹⁾) (UART0 to UART6)
A/D Converter		10-bit resolution × 34 channels Sample and hold functionality integrated Self test/Open-circuit detection assist
D/A Converter		8-bit resolution × 2
CRC Calculator		CRC-CCITT ($X^{16} + X^{12} + X^5 + 1$)
X-Y Converter		16 bits × 16 bits
Intelligent I/O		Time measurement (input capture): 16 bits × 16 Waveform generation (output compare): 16 bits × 24 Serial interface: Variable-length synchronous serial I/O mode, IEBus mode (optional ⁽¹⁾)
Multi-master I ² C-bus Interface		1 channel
Flash Memory		Programming and erasure supply voltage: VCC = 3.0 to 5.5 V Minimum endurance: 1,000 program/erase cycles Suspend/resume function available Security protection: ROM code protect, ID code protect Debugging: On-chip debug, on-board flash programming
Operating Frequency/Supply Voltage		64 MHz/VCC = 3.0 to 5.5 V
Operating Temperature		-40°C to 85°C (D version) -40°C to 85°C (P version)
Current Consumption		45 mA (VCC = 5.0 V, f(CPU) = 64 MHz) 8 μA (VCC = 3.3 V, f(XCIN) = 32.768 kHz, in wait mode)
Package		144-pin plastic molded LQFP (PLQP0144KA-A)

Note:

1. Contact a Renesas Electronics sales office to use the optional features.

1.4 Pin Assignments

Figures 1.3 and 1.4 show the pin assignments (top view) and Tables 1.6 to 1.13 show the pin characteristics.

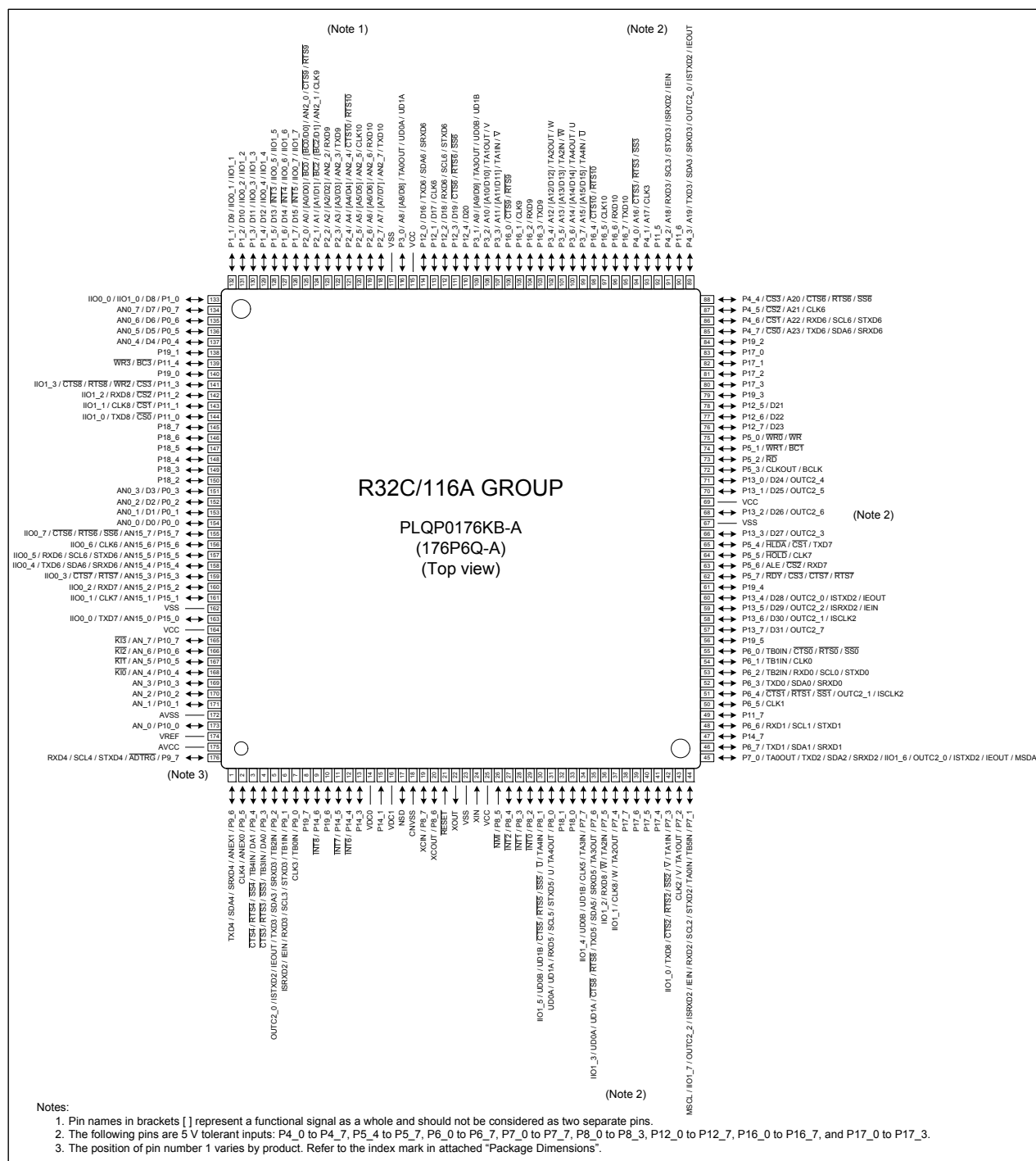


Figure 1.3 Pin Assignment for the 176-pin Package (top view)

Table 1.8 Pin Characteristics for the 176-pin Package (3/5)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
75		P5_0						WR0/WR
76		P12_7						D23
77		P12_6						D22
78		P12_5						D21
79		P19_3						
80		P17_3						
81		P17_2						
82		P17_1						
83		P17_0						
84		P19_2						
85		P4_7			TXD6/SDA6/SRXD6			CS0/A23
86		P4_6			RXD6/SCL6/STXD6			CS1/A22
87		P4_5			CLK6			CS2/A21
88		P4_4			CTS6/RTS6/SS6			CS3/A20
89		P4_3			TXD3/SDA3/SRXD3	OUTC2_0/ISTXD2/IEOUT		A19
90		P11_6						
91		P4_2			RXD3/SCL3/STXD3	ISRXD2/IEIN		A18
92		P11_5						
93		P4_1			CLK3			A17
94		P4_0			CTS3/RTS3/SS3			A16
95		P16_7			TXD10			
96		P16_6			RXD10			
97		P16_5			CLK10			
98		P16_4			CTS10/RTS10			
99		P3_7		TA4IN/ $\bar{U}$				A15/(D15)
100		P3_6		TA4OUT/U				A14/(D14)
101		P3_5		TA2IN/ $\bar{W}$				A13/(D13)
102		P3_4		TA2OUT/W				A12/(D12)
103		P16_3			TXD9			
104		P16_2			RXD9			
105		P16_1			CLK9			
106		P16_0			CTS9/RTS9			
107		P3_3		TA1IN/ $\bar{V}$				A11/(D11)
108		P3_2		TA1OUT/V				A10/(D10)
109		P3_1		TA3OUT		UD0B/UD1B		A9/(D9)
110		P12_4						D20
111		P12_3			CTS6/RTS6/SS6			D19
112		P12_2			RXD6/SCL6/STXD6			D18
113		P12_1			CLK6			D17
114		P12_0			TXD6/SDA6/SRXD6			D16

Table 1.13 Pin Characteristics for the 144-pin Package (3/4)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
75		P4_2			RXD3/SCL3/STXD3	ISRXD2/IEIN		A18
76		P11_5						
77		P4_1			CLK3			A17
78		P4_0			CTS3/RTS3/SS3			A16
79		P3_7		TA4IN/U				A15(/D15)
80		P3_6		TA4OUT/U				A14(/D14)
81		P3_5		TA2IN/W				A13(/D13)
82		P3_4		TA2OUT/W				A12(/D12)
83		P3_3		TA1IN/V				A11(/D11)
84		P3_2		TA1OUT/V				A10(/D10)
85		P3_1		TA3OUT		UD0B/UD1B		A9(/D9)
86		P12_4						D20
87		P12_3			CTS6/RTS6/SS6			D19
88		P12_2			RXD6/SCL6/STXD6			D18
89		P12_1			CLK6			D17
90		P12_0			TXD6/SDA6/SRXD6			D16
91	VCC							
92		P3_0		TA0OUT		UD0A/UD1A		A8(/D8)
93	VSS							
94		P2_7			TXD10		AN2_7	A7(/D7)
95		P2_6			RXD10		AN2_6	A6(/D6)
96		P2_5			CLK10		AN2_5	A5(/D5)
97		P2_4			CTS10/RTS10		AN2_4	A4(/D4)
98		P2_3			TXD9		AN2_3	A3(/D3)
99		P2_2			RXD9		AN2_2	A2(/D2)
100		P2_1			CLK9		AN2_1	A1(/D1)/ BC2(/D1)
101		P2_0			CTS9/RTS9		AN2_0	A0(/D0)/ BC0(/D0)
102		P1_7	INT5			IIO0_7/IIO1_7		D15
103		P1_6	INT4			IIO0_6/IIO1_6		D14
104		P1_5	INT3			IIO0_5/IIO1_5		D13
105		P1_4				IIO0_4/IIO1_4		D12
106		P1_3				IIO0_3/IIO1_3		D11
107		P1_2				IIO0_2/IIO1_2		D10
108		P1_1				IIO0_1/IIO1_1		D9
109		P1_0				IIO0_0/IIO1_0		D8
110		P0_7					AN0_7	D7
111		P0_6					AN0_6	D6

Table 1.14 Pin Characteristics for the 144-pin Package (4/4)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
112		P0_5					AN0_5	D5
113		P0_4					AN0_4	D4
114		P11_4						BC3/WR3
115		P11_3			CTS8/RTS8	IIO1_3		CS3/WR2
116		P11_2			RXD8	IIO1_2		CS2
117		P11_1			CLK8	IIO1_1		CS1
118		P11_0			TXD8	IIO1_0		CS0
119		P0_3					AN0_3	D3
120		P0_2					AN0_2	D2
121		P0_1					AN0_1	D1
122		P0_0					AN0_0	D0
123		P15_7			CTS6/RTS6/SS6	IIO0_7	AN15_7	
124		P15_6			CLK6	IIO0_6	AN15_6	
125		P15_5			RXD6/SCL6/STXD6	IIO0_5	AN15_5	
126		P15_4			TXD6/SDA6/SRXD6	IIO0_4	AN15_4	
127		P15_3			CTS7/RTS7	IIO0_3	AN15_3	
128		P15_2			RXD7	IIO0_2	AN15_2	
129		P15_1			CLK7	IIO0_1	AN15_1	
130	VSS							
131		P15_0			TXD7	IIO0_0	AN15_0	
132	VCC							
133		P10_7	KI3				AN_7	
134		P10_6	KI2				AN_6	
135		P10_5	KI1				AN_5	
136		P10_4	KI0				AN_4	
137		P10_3					AN_3	
138		P10_2					AN_2	
139		P10_1					AN_1	
140	AVSS							
141		P10_0					AN_0	
142	VREF							
143	AVCC							
144		P9_7			RXD4/SCL4/STXD4		ADTRG	

Table 1.19 Pin Specifications

Pin names	Package		Selectable Functions		5 V tolerant input ⁽³⁾
	176-pin	144-pin	Pull-up resistor ⁽¹⁾	N-channel open drain ⁽²⁾	
P0_0 to P0_7	✓	✓	✓		
P1_0 to P1_7	✓	✓	✓		
P2_0 to P2_7	✓	✓	✓	✓	
P3_0 to P3_7	✓	✓	✓		
P4_0 to P4_7	✓	✓		✓	✓
P5_0 to P5_3	✓	✓	✓		
P5_4 to P5_7	✓	✓		✓	✓
P6_0 to P6_7	✓	✓		✓	✓
P7_0 to P7_7	✓	✓		✓	✓
P8_0 to P8_3	✓	✓		✓	✓
P8_4, P8_6, P8_7	✓	✓	✓		
P9_0 to P9_7	✓	✓	✓	✓	
P10_0 to P10_7	✓	✓	✓		
P11_0 to P11_3	✓	✓	✓	✓	
P11_4 to P11_7	✓	✓	✓		
P12_0 to P12_7	✓	✓		✓	✓
P13_0 to P13_7	✓	✓	✓		
P14_1, P14_3	✓	✓	✓		
P14_4 to P14_7	✓	✓	✓		
P15_0 to P15_7	✓	✓	✓	✓	
P16_0 to P16_7	✓			✓	✓
P17_0 to P17_3	✓			✓	✓
P17_4 to P17_7	✓		✓		
P18_0 to P18_7	✓		✓		
P19_0 to P19_7	✓		✓		

Notes:

1. Pull-up resistors are selected for the following 4-pin units: Pi_0 to Pi_3 and Pi_4 to Pi_7 (i = 0 to 19); however, they are enabled only for the input pins.
2. N-channel open drain output can be enabled on the applicable pins on a discrete pin basis.
3. 5 V tolerant input is enabled when an applicable pin is set as an input port. When it is set as an I/O port, to enable 5 V tolerant input, this pin should be set as N-channel open drain output.

2. Central Processing Unit (CPU)

The CPU contains the registers shown below. There are two register banks each consisting of registers R2R0, R3R1, R6R4, R7R5, A0 to A3, SB, and FB.

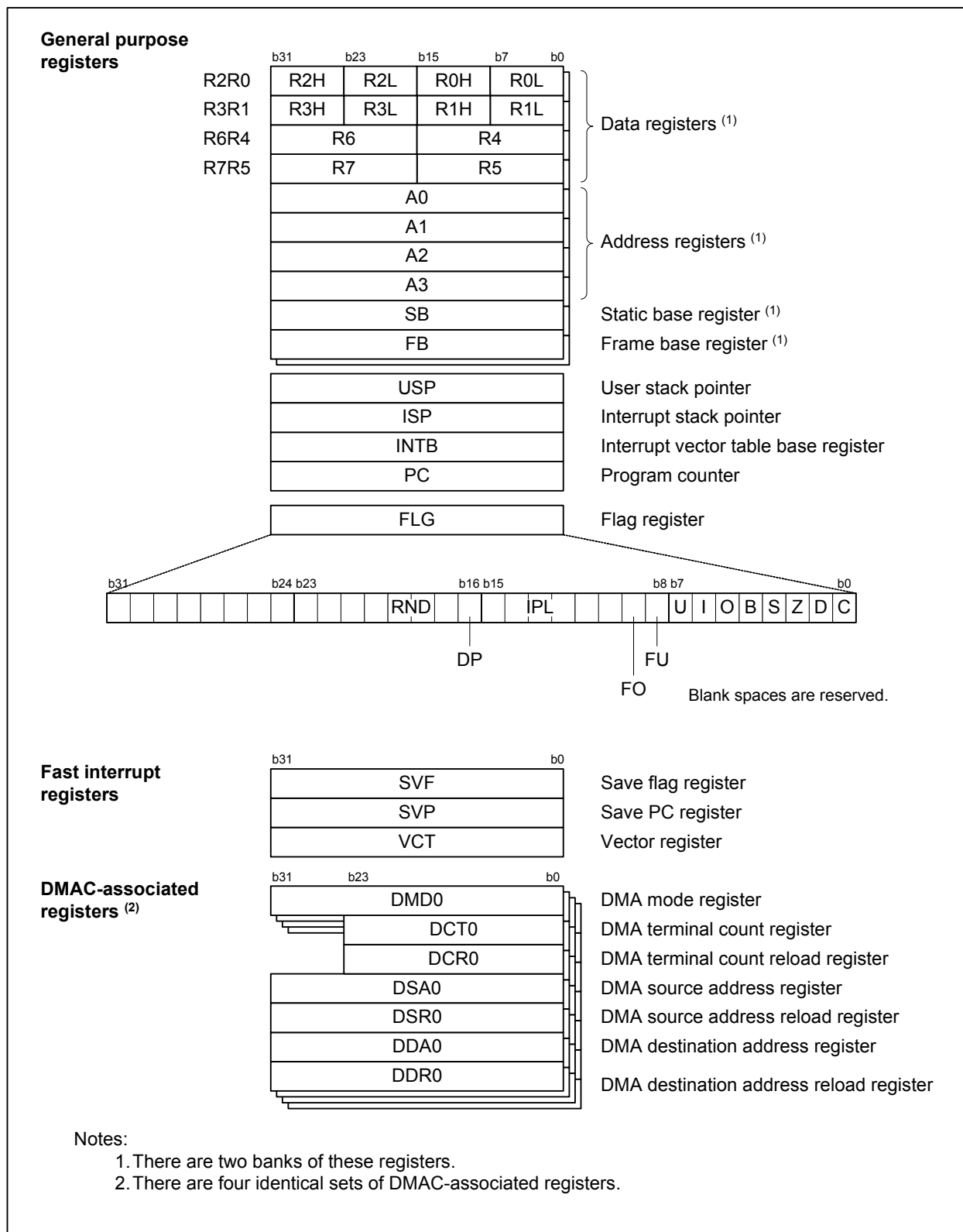


Figure 2.1 CPU Registers

2.1 General Purpose Registers

2.1.1 Data Registers (R2R0, R3R1, R6R4, and R7R5)

These 32-bit registers are primarily used for transfers and arithmetic/logic operations.

Each of the registers can be divided into upper and lower 16-bit registers, e.g. R2R0 can be divided into R2 and R0, R3R1 can be divided into R3 and R1, etc.

Moreover, data registers R2R0 and R3R1 can be divided into four 8-bit data registers: upper (R2H and R3H), mid-upper (R2L and R3L), mid-lower (R0H and R1H), and lower (R0L and R1L).

2.1.2 Address Registers (A0, A1, A2, and A3)

These 32-bit registers have functions similar to data registers. They are also used for address register indirect addressing and address register relative addressing.

2.1.3 Static Base Register (SB)

This 32-bit register is used for SB relative addressing.

2.1.4 Frame Base Register (FB)

This 32-bit register is used for FB relative addressing.

2.1.5 Program Counter (PC)

This 32-bit counter indicates the address of the instruction to be executed next.

2.1.6 Interrupt Vector Table Base Register (INTB)

This 32-bit register indicates the start address of a relocatable vector table.

2.1.7 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

Two types of 32-bit stack pointers (SPs) are provided: user stack pointer (USP) and interrupt stack pointer (ISP).

Use the stack pointer select flag (U flag) to select either the user stack pointer (USP) or the interrupt stack pointer (ISP). The U flag is bit 7 in the flag register (FLG). Refer to 2.1.8 "Flag Register (FLG)" for details.

To minimize the overhead of interrupt sequence due to less memory access, set the user stack pointer (USP) or the interrupt stack pointer (ISP) to a multiple of 4.

2.1.8 Flag Register (FLG)

This 32-bit register indicates the CPU status.

2.1.8.1 Carry Flag (C flag)

This flag retains a carry, borrow, or shifted-out bit generated by the arithmetic logic unit (ALU).

2.1.8.2 Debug Flag (D flag)

This flag is only for debugging. Only set this bit to 0.

2.1.8.3 Zero Flag (Z flag)

This flag becomes 1 when the result of an operation is 0; otherwise it is 0.

2.1.8.4 Sign Flag (S flag)

This flag becomes 1 when the result of an operation is a negative value; otherwise it is 0.

2.2 Fast Interrupt Registers

The following three registers are provided to minimize the overhead of the interrupt sequence.

2.2.1 Save Flag Register (SVF)

This 32-bit register is used to save the flag register when a fast interrupt occurs.

2.2.2 Save PC Register (SVP)

This 32-bit register is used to save the program counter when a fast interrupt occurs.

2.2.3 Vector Register (VCT)

This 32-bit register is used to indicate a jump address when a fast interrupt occurs.

2.3 DMAC-associated Registers

There are seven types of DMAC-associated registers.

2.3.1 DMA Mode Registers (DMD0, DMD1, DMD2, and DMD3)

These 32-bit registers are used to set DMA transfer mode, bit rate, etc.

2.3.2 DMA Terminal Count Registers (DCT0, DCT1, DCT2, and DCT3)

These 24-bit registers are used to set the number of DMA transfers.

2.3.3 DMA Terminal Count Reload Registers (DCR0, DCR1, DCR2, and DCR3)

These 24-bit registers are used to set the reloaded values for DMA terminal count registers.

2.3.4 DMA Source Address Registers (DSA0, DSA1, DSA2, and DSA3)

These 32-bit registers are used to set DMA source addresses.

2.3.5 DMA Source Address Reload Registers (DSR0, DSR1, DSR2, and DSR3)

These 32-bit registers are used to set the reloaded values for DMA source address registers.

2.3.6 DMA Destination Address Registers (DDA0, DDA1, DDA2, and DDA3)

These 32-bit registers are used to set DMA destination addresses.

2.3.7 DMA Destination Address Reload Registers (DDR0, DDR1, DDR2, and DDR3)

These 32-bit registers are used to set reloaded values for DMA destination address registers.

Table 4.7 SFR List (7)

Address	Register	Symbol	Reset Value
000140h	Group 2 Waveform Generation Register 0	G2PO0	XXXXh
000141h			
000142h	Group 2 Waveform Generation Register 1	G2PO1	XXXXh
000143h			
000144h	Group 2 Waveform Generation Register 2	G2PO2	XXXXh
000145h			
000146h	Group 2 Waveform Generation Register 3	G2PO3	XXXXh
000147h			
000148h	Group 2 Waveform Generation Register 4	G2PO4	XXXXh
000149h			
00014Ah	Group 2 Waveform Generation Register 5	G2PO5	XXXXh
00014Bh			
00014Ch	Group 2 Waveform Generation Register 6	G2PO6	XXXXh
00014Dh			
00014Eh	Group 2 Waveform Generation Register 7	G2PO7	XXXXh
00014Fh			
000150h	Group 2 Waveform Generation Control Register 0	G2POCR0	0000 0000b
000151h	Group 2 Waveform Generation Control Register 1	G2POCR1	0000 0000b
000152h	Group 2 Waveform Generation Control Register 2	G2POCR2	0000 0000b
000153h	Group 2 Waveform Generation Control Register 3	G2POCR3	0000 0000b
000154h	Group 2 Waveform Generation Control Register 4	G2POCR4	0000 0000b
000155h	Group 2 Waveform Generation Control Register 5	G2POCR5	0000 0000b
000156h	Group 2 Waveform Generation Control Register 6	G2POCR6	0000 0000b
000157h	Group 2 Waveform Generation Control Register 7	G2POCR7	0000 0000b
000158h			
000159h			
00015Ah			
00015Bh			
00015Ch			
00015Dh			
00015Eh			
00015Fh			
000160h	Group 2 Base Timer Register	G2BT	XXXXh
000161h			
000162h	Group 2 Base Timer Control Register 0	G2BCR0	0000 0000b
000163h	Group 2 Base Timer Control Register 1	G2BCR1	0000 0000b
000164h	Base Timer Start Register	BTSR	XXXX 0000b
000165h			
000166h	Group 2 Function Enable Register	G2FE	00h
000167h	Group 2 RTP Output Buffer Register	G2RTP	00h
000168h			
000169h			
00016Ah	Group 2 Serial Interface Mode Register	G2MR	00XX X000b
00016Bh	Group 2 Serial Interface Control Register	G2CR	0000 X110b
00016Ch	Group 2 SI/O Transmit Buffer Register	G2TB	XXXXh
00016Dh			
00016Eh	Group 2 SI/O Receive Buffer Register	G2RB	XXXXh
00016Fh			

X: Undefined

Blanks are reserved. No access is allowed.

Table 4.12 SFR List (12)

Address	Register	Symbol	Reset Value
0002F0h			
0002F1h			
0002F2h			
0002F3h			
0002F4h	UART4 Special Mode Register 4	U4SMR4	00h
0002F5h	UART4 Special Mode Register 3	U4SMR3	00h
0002F6h	UART4 Special Mode Register 2	U4SMR2	00h
0002F7h	UART4 Special Mode Register	U4SMR	00h
0002F8h	UART4 Transmit/Receive Mode Register	U4MR	00h
0002F9h	UART4 Bit Rate Register	U4BRG	XXh
0002FAh	UART4 Transmit Buffer Register	U4TB	XXXXh
0002FBh			
0002FCh	UART4 Transmit/Receive Control Register 0	U4C0	0000 1000b
0002FDh	UART4 Transmit/Receive Control Register 1	U4C1	0000 0010b
0002FEh	UART4 Receive Buffer Register	U4RB	XXXXh
0002FFh			
000300h	Count Start Register for Timers B3, B4, and B5	TBSR	000X XXXXb
000301h			
000302h	Timer A1-1 Register	TA11	XXXXh
000303h			
000304h	Timer A2-1 Register	TA21	XXXXh
000305h			
000306h	Timer A4-1 Register	TA41	XXXXh
000307h			
000308h	Three-phase PWM Control Register 0	INVC0	00h
000309h	Three-phase PWM Control Register 1	INVC1	00h
00030Ah	Three-phase Output Buffer Register 0	IDB0	XX11 1111b
00030Bh	Three-phase Output Buffer Register 1	IDB1	XX11 1111b
00030Ch	Dead Time Timer	DTT	XXh
00030Dh	Timer B2 Interrupt Generating Frequency Set Counter	ICTB2	XXh
00030Eh			
00030Fh			
000310h	Timer B3 Register	TB3	XXXXh
000311h			
000312h	Timer B4 Register	TB4	XXXXh
000313h			
000314h	Timer B5 Register	TB5	XXXXh
000315h			
000316h			
000317h			
000318h			
000319h			
00031Ah			
00031Bh	Timer B3 Mode Register	TB3MR	00XX 0000b
00031Ch	Timer B4 Mode Register	TB4MR	00XX 0000b
00031Dh	Timer B5 Mode Register	TB5MR	00XX 0000b
00031Eh			
00031Fh			

X: Undefined

Blanks are reserved. No access is allowed.

Table 4.21 SFR List (21)

Address	Register	Symbol	Reset Value
0400C0h	Port P4_0 Function Select Register	P4_0S	X0XX X000b
0400C1h	Port P5_0 Function Select Register	P5_0S	XXXX X000b
0400C2h	Port P4_1 Function Select Register	P4_1S	X0XX X000b
0400C3h	Port P5_1 Function Select Register	P5_1S	XXXX X000b
0400C4h	Port P4_2 Function Select Register	P4_2S	X0XX X000b
0400C5h	Port P5_2 Function Select Register	P5_2S	XXXX X000b
0400C6h	Port P4_3 Function Select Register	P4_3S	X0XX X000b
0400C7h	Port P5_3 Function Select Register	P5_3S	XXXX X000b
0400C8h	Port P4_4 Function Select Register	P4_4S	X0XX X000b
0400C9h	Port P5_4 Function Select Register	P5_4S	X0XX X000b
0400CAh	Port P4_5 Function Select Register	P4_5S	X0XX X000b
0400CBh	Port P5_5 Function Select Register	P5_5S	X0XX X000b
0400CCh	Port P4_6 Function Select Register	P4_6S	X0XX X000b
0400CDh	Port P5_6 Function Select Register	P5_6S	X0XX X000b
0400CEh	Port P4_7 Function Select Register	P4_7S	X0XX X000b
0400CFh	Port P5_7 Function Select Register	P5_7S	X0XX X000b
0400D0h	Port P6_0 Function Select Register	P6_0S	X0XX X000b
0400D1h	Port P7_0 Function Select Register	P7_0S	X0XX X000b
0400D2h	Port P6_1 Function Select Register	P6_1S	X0XX X000b
0400D3h	Port P7_1 Function Select Register	P7_1S	X0XX X000b
0400D4h	Port P6_2 Function Select Register	P6_2S	X0XX X000b
0400D5h	Port P7_2 Function Select Register	P7_2S	X0XX X000b
0400D6h	Port P6_3 Function Select Register	P6_3S	X0XX X000b
0400D7h	Port P7_3 Function Select Register	P7_3S	X0XX X000b
0400D8h	Port P6_4 Function Select Register	P6_4S	X0XX X000b
0400D9h	Port P7_4 Function Select Register	P7_4S	X0XX X000b
0400DAh	Port P6_5 Function Select Register	P6_5S	X0XX X000b
0400DBh	Port P7_5 Function Select Register	P7_5S	X0XX X000b
0400DCh	Port P6_6 Function Select Register	P6_6S	X0XX X000b
0400DDh	Port P7_6 Function Select Register	P7_6S	X0XX X000b
0400DEh	Port P6_7 Function Select Register	P6_7S	X0XX X000b
0400DFh	Port P7_7 Function Select Register	P7_7S	X0XX X000b
0400E0h	Port P8_0 Function Select Register	P8_0S	X0XX X000b
0400E1h	Port P9_0 Function Select Register	P9_0S	X0XX X000b
0400E2h	Port P8_1 Function Select Register	P8_1S	X0XX X000b
0400E3h	Port P9_1 Function Select Register	P9_1S	X0XX X000b
0400E4h	Port P8_2 Function Select Register	P8_2S	X0XX X000b
0400E5h	Port P9_2 Function Select Register	P9_2S	X0XX X000b
0400E6h	Port P8_3 Function Select Register	P8_3S	X0XX X000b
0400E7h	Port P9_3 Function Select Register	P9_3S	00XX X000b
0400E8h	Port P8_4 Function Select Register	P8_4S	XXXX X000b
0400E9h	Port P9_4 Function Select Register	P9_4S	00XX X000b
0400EAh			
0400EBh	Port P9_5 Function Select Register	P9_5S	00XX X000b
0400ECh	Port P8_6 Function Select Register	P8_6S	XXXX X000b
0400EDh	Port P9_6 Function Select Register	P9_6S	00XX X000b
0400EEh	Port P8_7 Function Select Register	P8_7S	XXXX X000b
0400EFh	Port P9_7 Function Select Register	P9_7S	X0XX X000b

X: Undefined

Blanks are reserved. No access is allowed.

Table 5.7 Electrical Characteristics of RAM
($V_{CC} = 3.0$ to 5.5 V, $V_{SS} = 0$ V, and $T_a = T_{opr}$, unless otherwise noted)

Symbol	Characteristic	Measurement Condition	Value			Unit
			Min.	Typ.	Max.	
V_{RDR}	RAM data retention voltage	In stop mode	2.0			V

Table 5.8 Electrical Characteristics of Flash Memory
($V_{CC} = 3.0$ to 5.5 V, $V_{SS} = 0$ V, and $T_a = T_{opr}$, unless otherwise noted)

Symbol	Characteristic		Value			Unit
			Min.	Typ.	Max.	
—	Program/erase cycles ⁽¹⁾	Program area	1000			Cycles
		Data area	10000			Cycles
—	4-word program time	Program area		150	900	μ s
		Data area		300	1700	μ s
—	Lock bit program time	Program area		70	500	μ s
		Data area		140	1000	μ s
—	Block erasure time	4-Kbyte block		0.12	3.0	s
		32-Kbyte block		0.17	3.0	s
		64-Kbyte block		0.20	3.0	s
t_{SUSP}	Suspend latency				250	μ s
—	Data retention ⁽²⁾	$T_a = 55^\circ\text{C}$ ⁽³⁾	10			Years

Notes:

1. Program/erase definition

This value represents the number of erasures per block.

When the number of program/erase cycles is n, each block can be erased n times.

For example, if a 4-word write is performed in 512 different addresses in the 4-Kbyte block A and then the block is erased, this is counted as a single program/erase operation.

However, the same address cannot be written to more than once per erasure (overwrite disabled).

2. Data retention includes periods when no supply voltage is applied and no clock is provided.

3. Contact a Renesas Electronics sales office for data retention times other than the above condition.

Timing Requirements ($V_{CC} = 3.0$ to 5.5 V, $V_{SS} = 0$ V, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.14 Flash Memory CPU Rewrite Mode Timing

Symbol	Characteristics	Value		Unit
		Min.	Max.	
t_{cR}	Read cycle time	200		ns
$t_{su(S-R)}$	Chip-select setup time before read	200		ns
$t_{h(R-S)}$	Chip-select hold time after read	0		ns
$t_{su(A-R)}$	Address setup time before read	200		ns
$t_{h(R-A)}$	Address hold time after read	0		ns
$t_{w(R)}$	Read pulse width	100		ns
t_{cW}	Write cycle time	200		ns
$t_{su(S-W)}$	Chip-select setup time before write	0		ns
$t_{h(W-S)}$	Chip-select hold time after write	30		ns
$t_{su(A-W)}$	Address setup time before write	0		ns
$t_{h(W-A)}$	Address hold time after write	30		ns
$t_{w(W)}$	Write pulse width	50		ns

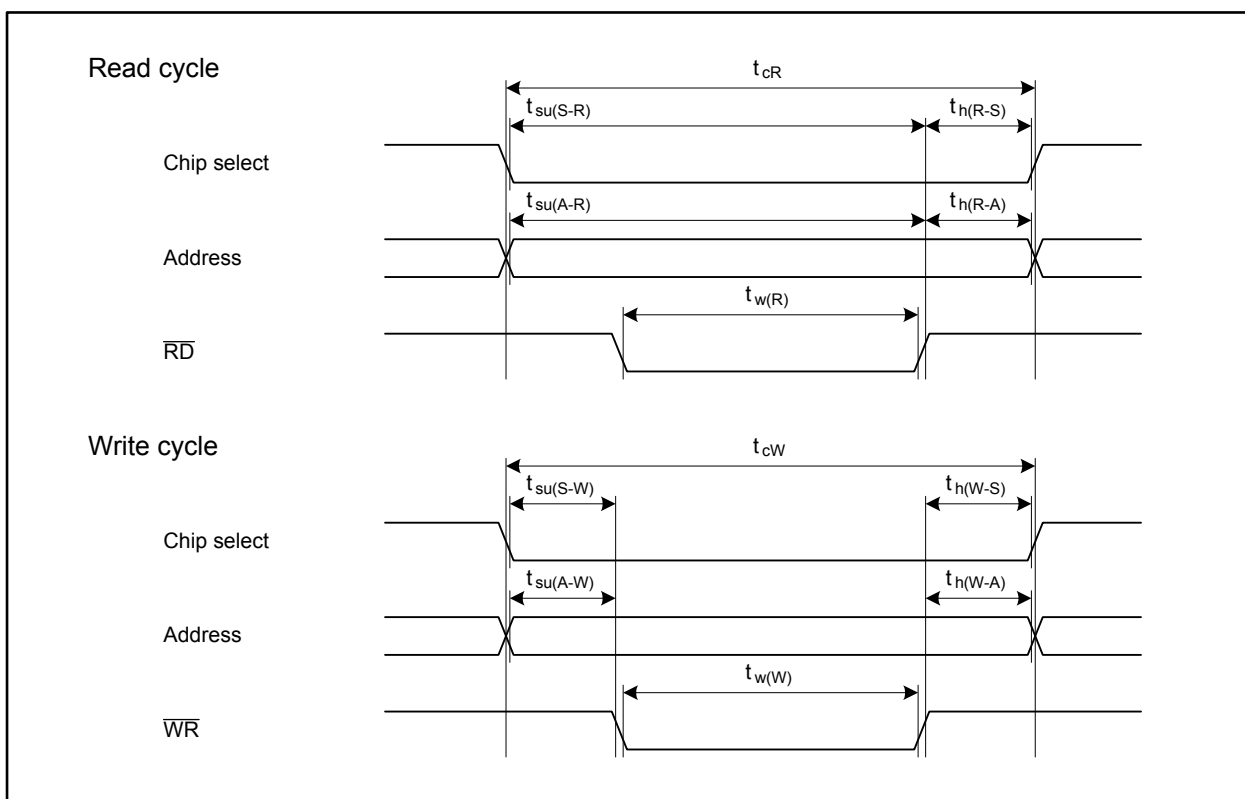


Figure 5.5 Flash Memory CPU Rewrite Mode Timing

$$V_{CC} = 5 \text{ V}$$

Table 5.16 Electrical Characteristics (2/3)(V_{CC} = 4.2 to 5.5 V, V_{SS} = 0 V, T_a = T_{opr}, and f_(CPU) = 64 MHz, unless otherwise noted)

Symbol	Characteristic	Measurement Condition	Value			Unit
			Min.	Typ.	Max.	
V _{T+} - V _{T-}	Hysteresis	HOLD, RDY, NMI, INT0 to INT8, KI0 to KI3, TA0IN to TA4IN, TA0OUT to TA4OUT, TB0IN to TB5IN, CTS0 to CTS10, CLK0 to CLK10, RXD0 to RXD10, SCL0 to SCL6, SDA0 to SDA6, SS0 to SS6, SRXD0 to SRXD6, ADTRG, IIO0_0 to IIO0_7, IIO1_0 to IIO1_7, UD0A, UD0B, UD1A, UD1B, ISCLK2, ISRXD2, IEIN, MSCL, MSDA RESET	0.2		1.0	V
			0.2		1.8	V
I _{IH}	High level input current	XIN, RESET, CNVSS, NSD, P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_1, P14_3 to P14_7, P15_0 to P15_7, P16_0 to P16_7, P17_0 to P17_7, P18_0 to P18_7, P19_0 to P19_7 (1)	V _I = 5 V			5.0 μA
I _{IL}	Low level input current	XIN, RESET, CNVSS, NSD, P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_1, P14_3 to P14_7, P15_0 to P15_7, P16_0 to P16_7, P17_0 to P17_7, P18_0 to P18_7, P19_0 to P19_7 (1)	V _I = 0 V			-5.0 μA
R _{PULLUP}	Pull-up resistor	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P5_0 to P5_3, P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P13_0 to P13_7, P14_1, P14_3 to P14_7, P15_0 to P15_7, P17_4 to P17_7, P18_0 to P18_7, P19_0 to P19_7 (1)	V _I = 0 V			30 50 170 kΩ
R _{fXIN}	Feedback resistor	XIN		1.5		MΩ
R _{fXCIN}	Feedback resistor	XCIN		15		MΩ

Note:

- Ports P16 to P19 are available in the 176-pin package only.

$$V_{CC} = 5 \text{ V}$$

Switching Characteristics ($V_{CC} = 4.2$ to 5.5 V , $V_{SS} = 0 \text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.35 External Bus Timing (separate bus)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{su(S-R)}$	Chip-select setup time before read	Refer to Figure 5.6	(1)		ns
$t_{h(R-S)}$	Chip-select hold time after read		$t_{c(Base)} - 15$		ns
$t_{su(A-R)}$	Address setup time before read		(1)		ns
$t_{h(R-A)}$	Address hold time after read		$t_{c(Base)} - 15$		ns
$t_{w(R)}$	Read pulse width		(1)		ns
$t_{su(S-W)}$	Chip-select setup time before write		(1)		ns
$t_{h(W-S)}$	Chip-select hold time after write		$1.5 \times t_{c(Base)} - 15$		ns
$t_{su(A-W)}$	Address setup time before write		(1)		ns
$t_{h(W-A)}$	Address hold time after write		$1.5 \times t_{c(Base)} - 15$		ns
$t_{w(W)}$	Write pulse width		(1)		ns
$t_{su(D-W)}$	Data setup time before write		(1)		ns
$t_{h(W-D)}$	Data hold time after write		0		ns

Note:

- The value is calculated using the formulas below based on the base clock cycles ($t_{c(Base)}$) and respective cycles of $T_{su(A-R)}$, $T_{w(R)}$, $T_{su(A-W)}$, and $T_{w(W)}$ set by registers EBC0 to EBC3. If the calculation results in a negative value, modify the value to be set. For details on how to set values, refer to the User's manual.

$$t_{su(S-R)} = t_{su(A-R)} = T_{su(A-R)} \times t_{c(Base)} - 15 \text{ [ns]}$$

$$t_{w(R)} = T_{w(R)} \times t_{c(Base)} - 10 \text{ [ns]}$$

$$t_{su(S-W)} = t_{su(A-W)} = T_{su(A-W)} \times t_{c(Base)} - 15 \text{ [ns]}$$

$$t_{w(W)} = t_{su(D-W)} = T_{w(W)} \times t_{c(Base)} - 10 \text{ [ns]}$$

$$V_{CC} = 5 \text{ V}$$

Switching Characteristics ($V_{CC} = 4.2$ to 5.5 V , $V_{SS} = 0 \text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.37 Serial Interface

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(C-Q)}$	TXDi output delay time	Refer to Figure 5.6		80	ns
$t_{h(C-Q)}$	TXDi output hold time		0		ns

Table 5.38 Intelligent I/O

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(ISCLK2-TXD)}$	ISTXD2 output delay time	Refer to Figure 5.6		180	ns
$t_{h(ISCLK2-RXD)}$	ISTXD2 output hold time		0		ns

Table 5.39 Multi-master I²C-bus Interface (standard-mode)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2		ns
$t_{f(SDA)}$	MSDA output fall time		2		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$20 \times t_{C(\phi IIC)} - 120$	$52 \times t_{C(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$20 \times t_{C(\phi IIC)} + 40$	$52 \times t_{C(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{C(\phi IIC)} + 40$	$3 \times t_{C(\phi IIC)} + 120$	ns

Table 5.40 Multi-master I²C-bus Interface (fast-mode)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2 (1)		ns
$t_{f(SDA)}$	MSDA output fall time		2 (1)		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$10 \times t_{C(\phi IIC)} - 120$	$26 \times t_{C(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$10 \times t_{C(\phi IIC)} + 40$	$26 \times t_{C(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{C(\phi IIC)} + 40$	$3 \times t_{C(\phi IIC)} + 120$	ns

Note:

1. External circuits are required to satisfy the I²C-bus specification.

$$V_{CC} = 3.3 \text{ V}$$

Timing Requirements ($V_{CC} = 3.0$ to 3.6 V , $V_{SS} = 0 \text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.56 Serial Interface

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{c(CK)}$	CLKi input clock cycle time	200		ns
$t_{w(CKH)}$	CLKi input high level pulse width	80		ns
$t_{w(CKL)}$	CLKi input low level pulse width	80		ns
$t_{su(D-C)}$	RXDi input setup time	80		ns
$t_{h(C-D)}$	RXDi input hold time	90		ns

Table 5.57 A/D Trigger Input

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{w(ADH)}$	ADTRG input high level pulse width Hardware trigger input high level pulse width	$\frac{3}{\phi_{AD}}$		ns
$t_{w(ADL)}$	ADTRG input low level pulse width Hardware trigger input high level pulse width	125		ns

Table 5.58 External Interrupt $\overline{INTi}$ Input

Symbol	Characteristic		Value		Unit
			Min.	Max.	
$t_{w(INH)}$	$\overline{INTi}$ input high level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{c(CPU)} + 200$		ns
$t_{w(INL)}$	$\overline{INTi}$ input low level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{c(CPU)} + 200$		ns

Table 5.59 Intelligent I/O

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{c(ISCLK2)}$	ISCLK2 input clock cycle time	600		ns
$t_{w(ISCLK2H)}$	ISCLK2 input high level pulse width	270		ns
$t_{w(ISCLK2L)}$	ISCLK2 input low level pulse width	270		ns
$t_{su(RXD-ISCLK2)}$	ISRXD2 input setup time	150		ns
$t_{h(ISCLK2-RXD)}$	ISRXD2 input hold time	100		ns

$$V_{CC} = 3.3 \text{ V}$$

Switching Characteristics ($V_{CC} = 3.0$ to 3.6 V , $V_{SS} = 0 \text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.62 External Bus Timing (multiplexed bus)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{su(S-ALE)}$	Chip-select setup time before ALE	Refer to Figure 5.6	(1)		ns
$t_{h(R-S)}$	Chip-select hold time after read		$1.5 \times t_{c(Base)} - 15$		ns
$t_{su(A-ALE)}$	Address setup time before ALE		(1)		ns
$t_{h(ALE-A)}$	Address hold time after ALE		$t_{c(Base)} - 5$ (2)		ns
$t_{h(R-A)}$	Address hold time after read		$1.5 \times t_{c(Base)} - 15$		ns
$t_{d(ALE-R)}$	ALE-read delay time		$t_{c(Base)} - 5$ (2)	$t_{c(Base)} + 10$ (2)	ns
$t_{w(ALE)}$	ALE pulse width		(1)		ns
$t_{dis(R-A)}$	Address disable time after read			8	ns
$t_{w(R)}$	Read pulse width		(1)		ns
$t_{h(W-S)}$	Chip-select hold time after write		$1.5 \times t_{c(Base)} - 15$		ns
$t_{h(W-A)}$	Address hold time after write		$1.5 \times t_{c(Base)} - 15$		ns
$t_{d(ALE-W)}$	ALE-write delay time		$t_{c(Base)} - 5$ (2)	$t_{c(Base)} + 10$ (2)	ns
$t_{w(W)}$	Write pulse width		(1)		ns
$t_{su(D-W)}$	Data setup time before write		(1)		ns
$t_{h(W-D)}$	Data hold time after write		$0.5 \times t_{c(Base)}$		ns

Notes:

- The value is calculated using the formulas below based on the base clock cycles ($t_{c(Base)}$) and respective cycles of $T_{su(A-R)}$, $T_{w(R)}$, $T_{su(A-W)}$, and $T_{w(W)}$ set by registers EBC0 to EBC3. If the calculation results in a negative value, modify the value to be set. For details on how to set values, refer to the User's manual.

$$t_{su(S-ALE)} = t_{su(A-ALE)} = (T_{su(A-R)} - 1) \times t_{c(Base)} - 15 \text{ [ns]} \text{ (when } T_{su(A-R)} \text{ is greater than 1)}$$

$$t_{su(S-ALE)} = t_{su(A-ALE)} = 0.5 \times t_{c(Base)} - 15 \text{ [ns]} \text{ (when } T_{su(A-R)} \text{ is 1)}$$

$$t_{w(ALE)} = (T_{su(A-R)} - 1) \times t_{c(Base)} - 20 \text{ [ns]} \text{ (when } T_{su(A-R)} \text{ is greater than 1)}$$

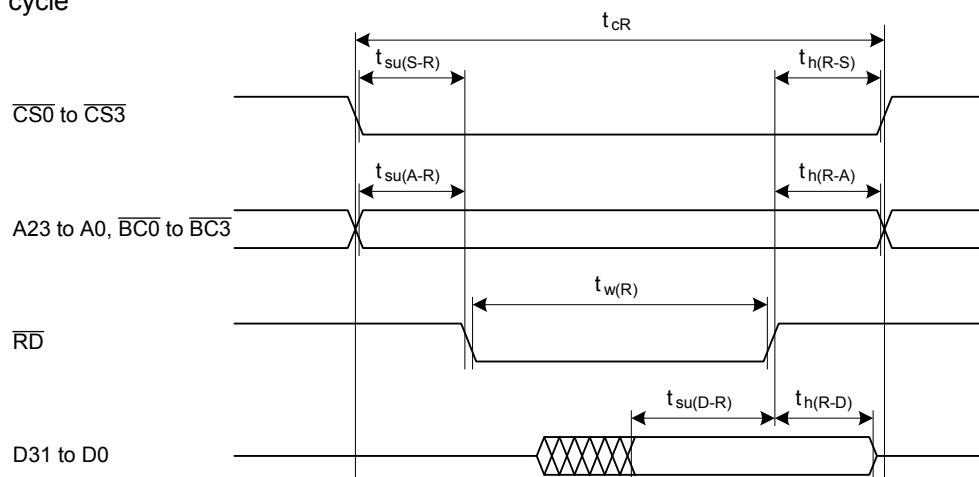
$$t_{w(ALE)} = 0.5 \times t_{c(Base)} - 20 \text{ [ns]} \text{ (when } T_{su(A-R)} \text{ is 1)}$$

$$t_{w(R)} = T_{w(R)} \times t_{c(Base)} - 10 \text{ [ns]}$$

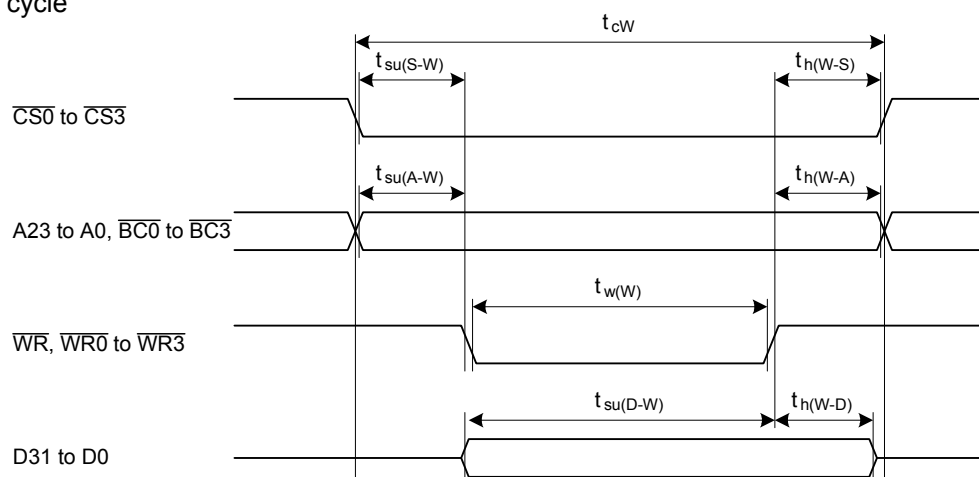
$$t_{w(W)} = t_{su(D-W)} = T_{w(W)} \times t_{c(Base)} - 10 \text{ [ns]}$$
- When $T_{su(A-R)}$ is greater than 1 or $T_{su(A-W)}$ is greater than 1. Change " $t_{c(Base)}$ " to " $0.5 \times t_{c(Base)}$ " when $T_{su(A-R)}$ is 1 or $T_{su(A-W)}$ is 1.

External bus timing (separate bus)

Read cycle



Write cycle



Measurement conditions

Item		$V_{CC} = 4.2$ to 5.5 V	$V_{CC} = 3.0$ to 3.6 V
Criterion for input voltage	V_{IH}	2.5 V	1.5 V
	V_{IL}	0.8 V	0.5 V
Criterion for output voltage	V_{OH}	2.0 V	2.4 V
	V_{OL}	0.8 V	0.5 V

Figure 5.8 External Bus Timing for Separate Bus